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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	M16C/60
Core Size	16-Bit
Speed	32MHz
Connectivity	EBI/EMI, I ² C, SIO, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	20K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	128-LQFP
Supplier Device Package	128-LFQFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f3651edfc-u0

Table 1.3 Specifications for the 100-Pin Package (1/2)

Item	Function	Description
CPU	Central processing unit	<p>M16C/60 Series core (multiplier: 16 bit × 16 bit → 32 bit, multiply and accumulate instruction: 16 bit × 16 bit + 32 bit → 32 bit)</p> <ul style="list-style-type: none"> • Number of basic instructions: 91 • Minimum instruction execution time: 31.25 ns ($f(BCLK) = 32$ MHz, VCC1 = VCC2 = 2.7 to 5.5 V) • Operating modes: Single-chip, memory expansion, and microprocessor
Memory	ROM, RAM, data flash	See Table 1.5 "Product List (1/2)" and Table 1.6 "Product List (2/2)".
Voltage Detection	Voltage detector	<ul style="list-style-type: none"> • Power-on reset • 3 voltage detection points (detection level of voltage detection 0 and 1 selectable)
Clock	Clock generator	<ul style="list-style-type: none"> • 5 circuits: Main clock, sub clock, low-speed on-chip oscillator (125 kHz), high-speed on-chip oscillator (40 MHz ±10%), PLL frequency synthesizer • Oscillation stop detection: Main clock oscillation stop/restart detection function • Frequency divider circuit: Divide ratio selectable from 1, 2, 4, 8, and 16 • Power saving features: Wait mode, stop mode • Real-time clock
External Bus Expansion	Bus memory expansion	<ul style="list-style-type: none"> • Address space: 1 MB • External bus interface: 0 to 8 waits inserted, 4 chip select outputs, memory area expansion function (expandable to 4 MB), 3 V and 5 V interfaces • Bus format: Separate bus or multiplexed bus selectable, data bus width selectable (8 or 16 bits), number of address buses selectable (12, 16, or 20)
I/O Ports	Programmable I/O ports	<ul style="list-style-type: none"> • CMOS I/O ports: 85 (selectable pull-up resistors) • N-channel open drain ports: 3
Interrupts		<ul style="list-style-type: none"> • Interrupt vectors: 70 • External interrupt inputs: 13 (\overline{NMI}, $\overline{INT} \times 8$, key input × 4) • Interrupt priority levels: 7
Watchdog Timer		15-bit timer × 1 (with prescaler) Automatic reset start function selectable
DMA	DMAC	<ul style="list-style-type: none"> • 4 channels, cycle steal mode • Trigger sources: 43 • Transfer modes: 2 (single transfer, repeat transfer)

Table 1.6 Product List (2/2)

As of July 2012

Part No.	ROM Capacity			RAM Capacity	Package Code	Remarks
	Program ROM 1	Program ROM 2	Data flash			
R5F3651TNFC	768 KB	16 KB	4 KB x 2 blocks	47 KB	PLQP0128KB-A	Operating temperature -20°C to 85°C
R5F3650TNFA					PRQP0100JD-B	
R5F3650TNFB					PLQP0100KB-A	
R5F3651TDFC					PLQP0128KB-A	Operating temperature -40°C to 85°C
R5F3650TDFA					PRQP0100JD-B	
R5F3650TDFB					PLQP0100KB-A	

(D): Under development

(P): Planning

Previous package codes are as follows:

PLQP0128KB-A: 128P6Q-A

PRQP0100JD-B: 100P6F-A

PLQP0100KB-A: 100P6Q-A

Table 1.9 Pin Names for the 128-Pin Package (3/3)

Pin No.	Control Pin	Port	I/O Pin for Peripheral Function				Bus Control Pin
			Interrupt	Timer	Serial interface	A/D converter, D/A converter	
101		P1_2			RXD6/SCL6		D10
102		P1_1			CLK6		D9
103		P1_0			CTS6/RTS6		D8
104		P0_7				AN0_7	D7
105		P0_6				AN0_6	D6
106		P0_5				AN0_5	D5
107		P0_4				AN0_4	D4
108		P0_3				AN0_3	D3
109		P0_2				AN0_2	D2
110		P0_1				AN0_1	D1
111		P0_0				AN0_0	D0
112		P11_7					
113		P11_6					
114		P11_5					
115		P11_4					
116		P11_3					
117		P11_2					
118		P11_1					
119		P11_0					
120		P10_7	KI3			AN7	
121		P10_6	KI2			AN6	
122		P10_5	KI1			AN5	
123		P10_4	KI0			AN4	
124		P10_3				AN3	
125		P10_2				AN2	
126		P10_1				AN1	
127	AVSS						
128		P10_0				AN0	

Table 1.10 Pin Names for the 100-Pin Package (1/2)

Pin No.	FA	FB	Control Pin	Port	I/O Pin for Peripheral Function				Bus Control Pin
					Interrupt	Timer	Serial interface	A/D converter, D/A converter	
1	99			P9_6			SOUT4	ANEX1	
2	100			P9_5			CLK4	ANEX0	
3	1			P9_4		TB4IN/PWM1		DA1	
4	2			P9_3		TB3IN/PWM0		DA0	
5	3			P9_2		TB2IN/PMC0	SOUT3		
6	4			P9_1		TB1IN/PMC1	SIN3		
7	5			P9_0		TB0IN	CLK3		
8	6	BYTE							
9	7	CNVSS							
10	8	XCIN	P8_7						
11	9	XCOOUT	P8_6						
12	10	RESET							
13	11	XOUT							
14	12	VSS							
15	13	XIN							
16	14	VCC1							
17	15		P8_5	NMI	SD	CEC			
18	16		P8_4	INT2	ZP				
19	17		P8_3	INT1					
20	18		P8_2	INT0					
21	19		P8_1		TA4IN/U	CTS5/RTS5			
22	20		P8_0		TA4OUT/U	RXD5/SCL5			
23	21		P7_7		TA3IN	CLK5			
24	22		P7_6		TA3OUT	TXD5/SDA5			
25	23		P7_5		TA2IN/W				
26	24		P7_4		TA2OUT/W				
27	25		P7_3		TA1IN/V	CTS2/RTS2			
28	26		P7_2		TA1OUT/V	CLK2			
29	27		P7_1		TA0IN/TB5IN	RXD2/SCL2/SCLMM			
30	28		P7_0		TA0OUT	TXD2/SDA2/SDAMM			
31	29		P6_7			TXD1/SDA1			
32	30		P6_6			RXD1/SCL1			
33	31		P6_5			CLK1			
34	32		P6_4			CTS1/RTS1/CTS0/ CLKS1			
35	33		P6_3			TXD0/SDA0			
36	34		P6_2			RXD0/SCL0			
37	35		P6_1			CLK0			
38	36		P6_0	RTCOUT		CTS0/RTS0			
39	37	CLKOUT	P5_7					RDY	
40	38		P5_6					ALE	
41	39		P5_5					HOLD	
42	40		P5_4					HLDA	
43	41		P5_3					BCLK	
44	42		P5_2					RD	
45	43		P5_1					WRH/BHE	
46	44		P5_0					WRL/WR	
47	45		P4_7	PWM1	TXD7/SDA7			CS3	
48	46		P4_6	PWM0	RXD7/SCL7			CS2	
49	47		P4_5			CLK7		CS1	
50	48		P4_4			CTS7/RTS7		CS0	

Table 1.16 Pin Functions for the 100-Pin Package (2/3)

Signal Name	Pin Name	I/O	Power Supply	Description
Main clock input	XIN	I	VCC1	I/O for the main clock oscillator. Connect a ceramic resonator or crystal between pins XIN and XOUT. (1)
Main clock output	XOUT	O	VCC1	Input an external clock to XIN pin and leave XOUT pin open.
Sub clock input	XCIN	I	VCC1	I/O for a sub clock oscillator. Connect a crystal between XCIN pin and XCOUT pin. (1) Input an external clock to XCIN pin and leave XCOUT pin open.
Sub clock output	XCOUT	O	VCC1	
BCLK output	BCLK	O	VCC2	Outputs the BCLK signal.
Clock output	CLKOUT	O	VCC2	Outputs a clock with the same frequency as fC, f1, f8, or f32.
INT interrupt input	INT0 to INT2	I	VCC1	Input for the INT interrupt.
	INT3 to INT7	I	VCC2	
NMI interrupt input	NMI	I	VCC1	Input for the NMI interrupt.
Key input interrupt input	KI0 to KI3	I	VCC1	Input for the key input interrupt.
Timer A	TA0OUT to TA4OUT	I/O	VCC1	I/O for timers A0 to A4 (TA0OUT is N-channel open drain output).
	TA0IN to TA4IN	I	VCC1	Input for timers A0 to A4.
	ZP	I	VCC1	Input for Z-phase.
Timer B	TB0IN to TB5IN	I	VCC1	Input for timers B0 to B5.
Three-phase motor control timer	U, \bar{U} , V, \bar{V} , W, \bar{W}	O	VCC1	Output for the three-phase motor control timer.
	SD	I	VCC1	Forced cutoff input.
	IDU, IDV, IDW	I	VCC2	Input for the position data.
Real-time clock output	RTCOUT	O	VCC1	Output for the real-time clock.
PWM output	PWM0, PWM1	O	VCC1, VCC2	PWM output.
Remote control signal receiver input	PMC0, PMC1	I	VCC1	Input for the remote control signal receiver.
Serial interface UART0 to UART2, UART5 to UART7	CTS0 to CTS2, CTS5	I	VCC1	Input pins to control data transmission.
	CTS6, CTS7	I	VCC2	
	RTS0 to RTS2, RTS5	O	VCC1	Output pins to control data reception.
	RTS6, RTS7	O	VCC2	
	CLK0 to CLK2, CLK5	I/O	VCC1	Transmit/receive clock I/O.
	CLK6, CLK7	I/O	VCC2	
	RXD0 to RXD2, RXD5	I	VCC1	Serial data input.
	RXD6, RXD7	I	VCC2	
	TXD0 to TXD2, TXD5	O	VCC1	Serial data output. (2)
	TXD6, TXD7	O	VCC2	
CLKS1				Output for the transmit/receive clock multiple-pin output function.

Notes:

1. Contact the manufacturer of crystal/ceramic resonator regarding the oscillation characteristics.
2. TXD2, SDA2, and SCL2 are N-channel open drain output pins. TXDi (i = 0, 1, 5 to 7), SDAi, and SCLi can be selected as CMOS output pins or N-channel open drain output pins.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. Seven registers (R0, R1, R2, R3, A0, A1, and FB) out of 13 compose a register bank, and there are two register banks.

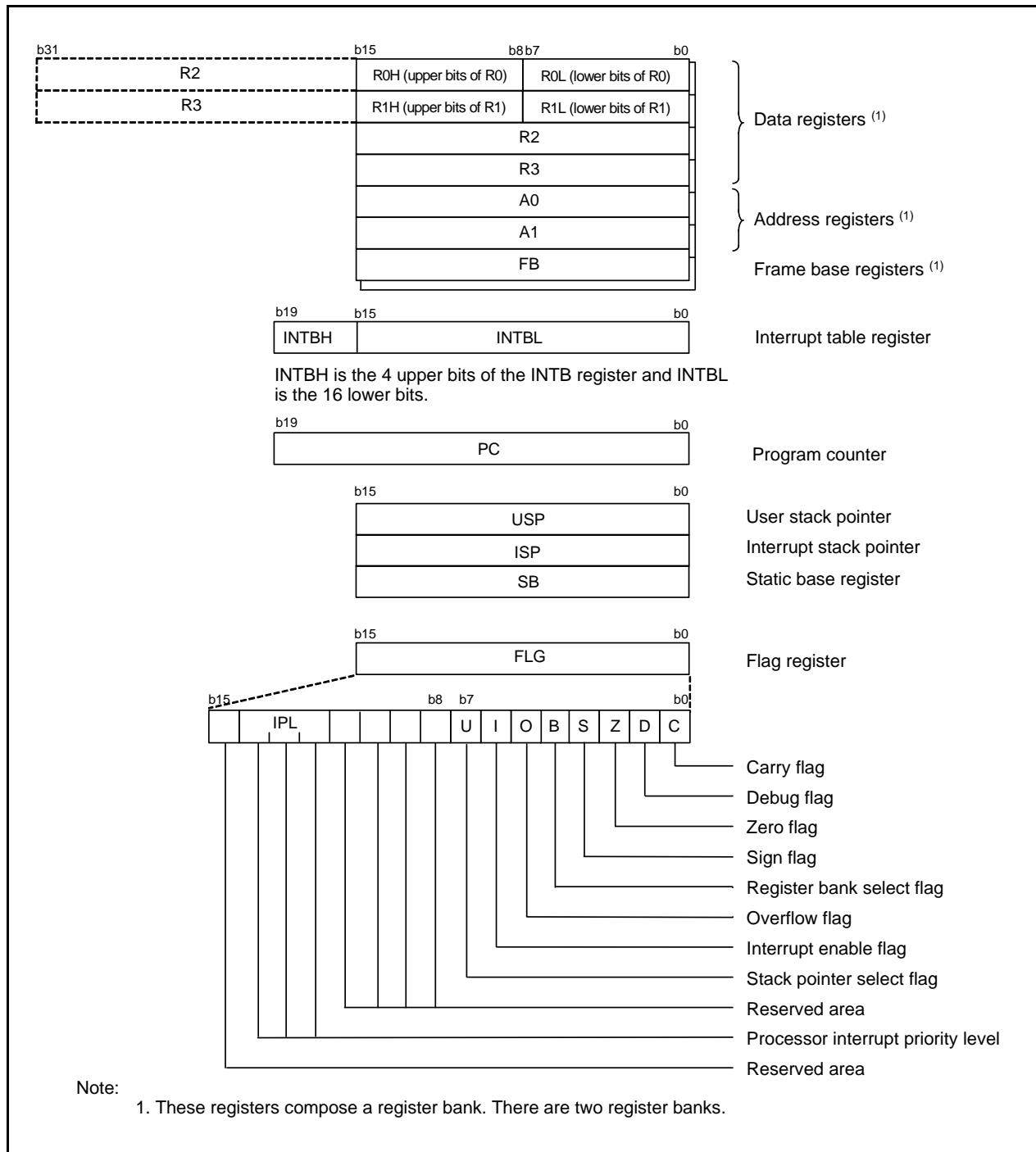


Figure 2.1 CPU Registers

2.8.7 Interrupt Enable Flag (I Flag)

The I flag enables maskable interrupts.

Maskable interrupts are disabled when the I flag is 0, and enabled when it is 1. The I flag becomes 0 when an interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0. USP is selected when the U flag is 1.

The U flag becomes 0 when a hardware interrupt request is accepted, or the INT instruction of software interrupt number 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from 0 to 7.

If a requested interrupt has higher priority than IPL, the interrupt request is enabled.

2.8.10 Reserved Areas

Only set these bits to 0. The read value is undefined.

Table 4.7 SFR Information (7) ⁽¹⁾

Address	Register	Symbol	Reset Value
01E0h	Timer B3-1 Register	TB31	XXh
01E1h			XXh
01E2h	Timer B4-1 Register	TB41	XXh
01E3h			XXh
01E4h	Timer B5-1 Register	TB51	XXh
01E5h			XXh
01E6h	Pulse Period/Pulse Width Measurement Mode Function Select Register 2	PPWFS2	XXXX X000b
01E7h			
01E8h	Timer B Count Source Select Register 2	TBCS2	00h
01E9h	Timer B Count Source Select Register 3	TBCS3	X0h
01EAh			
01EBh			
01EcH			
01EDh			
01EEh			
01EFh			
01F0h	PMC0 Function Select Register 0	PMC0CON0	00h
01F1h	PMC0 Function Select Register 1	PMC0CON1	00XX 0000b
01F2h	PMC0 Function Select Register 2	PMC0CON2	0000 00X0b
01F3h	PMC0 Function Select Register 3	PMC0CON3	00h
01F4h	PMC0 Status Register	PMC0STS	00h
01F5h	PMC0 Interrupt Source Select Register	PMC0INT	00h
01F6h	PMC0 Compare Control Register	PMC0CPC	XXX0 X000b
01F7h	PMC0 Compare Data Register	PMC0CPD	00h
01F8h	PMC1 Function Select Register 0	PMC1CON0	XXX0 X000b
01F9h	PMC1 Function Select Register 1	PMC1CON1	XXXX 0X00b
01FaH	PMC1 Function Select Register 2	PMC1CON2	0000 00X0b
01FBh	PMC1 Function Select Register 3	PMC1CON3	00h
01FcH	PMC1 Status Register	PMC1STS	X000 X00Xb
01FdH	PMC1 Interrupt Source Select Register	PMC1INT	X000 X00Xb
01FeH			
01FFh			
0200h			
0201h			
0202h			
0203h			
0204h			
0205h	Interrupt Source Select Register 3	IFSR3A	00h
0206h	Interrupt Source Select Register 2	IFSR2A	00h
0207h	Interrupt Source Select Register	IFSR	00h
0208h			
0209h			
020Ah			
020Bh			
020Ch			
020Dh			
020Eh	Address Match Interrupt Enable Register	AIER	XXXX XX00b
020Fh	Address Match Interrupt Enable Register 2	AIER2	XXXX XX00b

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 4.8 SFR Information (8) ⁽¹⁾

Address	Register	Symbol	Reset Value
0210h	Address Match Interrupt Register 0	RMAD0	00h
0211h			00h
0212h			X0h
0213h			
0214h	Address Match Interrupt Register 1	RMAD1	00h
0215h			00h
0216h			X0h
0217h			
0218h	Address Match Interrupt Register 2	RMAD2	00h
0219h			00h
021Ah			X0h
021Bh			
021Ch	Address Match Interrupt Register 3	RMAD3	00h
021Dh			00h
021Eh			X0h
021Fh			
0220h	Flash Memory Control Register 0	FMR0	0000 0001b (Other than user boot mode) 0010 0001b (User boot mode)
0221h	Flash Memory Control Register 1	FMR1	00X0 XX0Xb
0222h	Flash Memory Control Register 2	FMR2	XXXX 0000b
0223h			
0224h			
0225h			
0226h			
0227h			
0228h			
0229h			
022Ah			
022Bh			
022Ch			
022Dh			
022Eh			
022Fh			
0230h	Flash Memory Control Register 6	FMR6	XX0X XX00b
0231h			
0232h			
0233h			
0234h			
0235h			
0236h			
0237h			
0238h			
0239h			
023Ah			
023Bh			
023Ch			
023Dh			
023Eh			
023Fh			

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 4.9 SFR Information (9) ⁽¹⁾

Address	Register	Symbol	Reset Value
0240h			
0241h			
0242h			
0243h			
0244h	UART0 Special Mode Register 4	U0SMR4	00h
0245h	UART0 Special Mode Register 3	U0SMR3	000X 0X0Xb
0246h	UART0 Special Mode Register 2	U0SMR2	X000 0000b
0247h	UART0 Special Mode Register	U0SMR	X000 0000b
0248h	UART0 Transmit/Receive Mode Register	U0MR	00h
0249h	UART0 Bit Rate Register	U0BRG	XXh
024Ah	UART0 Transmit Buffer Register	U0TB	XXh
024Bh			XXh
024Ch	UART0 Transmit/Receive Control Register 0	U0C0	0000 1000b
024Dh	UART0 Transmit/Receive Control Register 1	U0C1	00XX 0010b
024Eh	UART0 Receive Buffer Register	U0RB	XXh
024Fh			XXh
0250h	UART Transmit/Receive Control Register 2	UCON	X000 0000b
0251h			
0252h	UART Clock Select Register	UCLKSEL0	X0h
0253h			
0254h	UART1 Special Mode Register 4	U1SMR4	00h
0255h	UART1 Special Mode Register 3	U1SMR3	000X 0X0Xb
0256h	UART1 Special Mode Register 2	U1SMR2	X000 0000b
0257h	UART1 Special Mode Register	U1SMR	X000 0000b
0258h	UART1 Transmit/Receive Mode Register	U1MR	00h
0259h	UART1 Bit Rate Register	U1BRG	XXh
025Ah	UART1 Transmit Buffer Register	U1TB	XXh
025Bh			XXh
025Ch	UART1 Transmit/Receive Control Register 0	U1C0	0000 1000b
025Dh	UART1 Transmit/Receive Control Register 1	U1C1	00XX 0010b
025Eh	UART1 Receive Buffer Register	U1RB	XXh
025Fh			XXh
0260h			
0261h			
0262h			
0263h			
0264h	UART2 Special Mode Register 4	U2SMR4	00h
0265h	UART2 Special Mode Register 3	U2SMR3	000X 0X0Xb
0266h	UART2 Special Mode Register 2	U2SMR2	X000 0000b
0267h	UART2 Special Mode Register	U2SMR	X000 0000b
0268h	UART2 Transmit/Receive Mode Register	U2MR	00h
0269h	UART2 Bit Rate Register	U2BRG	XXh
026Ah	UART2 Transmit Buffer Register	U2TB	XXh
026Bh			XXh
026Ch	UART2 Transmit/Receive Control Register 0	U2C0	0000 1000b
026Dh	UART2 Transmit/Receive Control Register 1	U2C1	0000 0010b
026Eh	UART2 Receive Buffer Register	U2RB	XXh
026Fh			XXh

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 4.11 SFR Information (11) ⁽¹⁾

Address	Register	Symbol	Reset Value
02A0h			
02A1h			
02A2h			
02A3h			
02A4h	UART7 Special Mode Register 4	U7SMR4	00h
02A5h	UART7 Special Mode Register 3	U7SMR3	000X 0X0Xb
02A6h	UART7 Special Mode Register 2	U7SMR2	X000 0000b
02A7h	UART7 Special Mode Register	U7SMR	X000 0000b
02A8h	UART7 Transmit/Receive Mode Register	U7MR	00h
02A9h	UART7 Bit Rate Register	U7BRG	XXh
02AAh	UART7 Transmit Buffer Register	U7TB	XXh
02ABh			XXh
02ACh	UART7 Transmit/Receive Control Register 0	U7C0	0000 1000b
02ADh	UART7 Transmit/Receive Control Register 1	U7C1	0000 0010b
02AEh	UART7 Receive Buffer Register	U7RB	XXh
02AFh			XXh
02B0h	I2C0 Data Shift Register	S00	XXh
02B1h			
02B2h	I2C0 Address Register 0	S0D0	0000 000Xb
02B3h	I2C0 Control Register 0	S1D0	00h
02B4h	I2C0 Clock Control Register	S20	00h
02B5h	I2C0 Start/Stop Condition Control Register	S2D0	0001 1010b
02B6h	I2C0 Control Register 1	S3D0	0011 0000b
02B7h	I2C0 Control Register 2	S4D0	00h
02B8h	I2C0 Status Register 0	S10	0001 000Xb
02B9h	I2C0 Status Register 1	S11	XXXX X000b
02BAh	I2C0 Address Register 1	S0D1	0000 000Xb
02BBh	I2C0 Address Register 2	S0D2	0000 000Xb
02BCh			
02BDh			
02BEh			
02BFh			
02C0h to 02FFh			

X: Undefined

Note:

- The blank areas are reserved. No access is allowed.

4.2 Notes on SFRs

4.2.1 Register Settings

Table 4.19 lists Registers with Write-Only Bits and registers whose function differs between reading and writing. Set these registers with immediate values. Do not use read-modify-write instructions. When establishing the next value by altering the existing value, write the existing value to the RAM as well as to the register. Transfer the next value to the register after making changes in the RAM.

Read-modify-write instructions can be used when writing to the no register bits.

Table 4.19 Registers with Write-Only Bits

Address	Register	Symbol
0249h	UART0 Bit Rate Register	U0BRG
024Bh to 024Ah	UART0 Transmit Buffer Register	U0TB
0259h	UART1 Bit Rate Register	U1BRG
025Bh to 025Ah	UART1 Transmit Buffer Register	U1TB
0269h	UART2 Bit Rate Register	U2BRG
026Bh to 026Ah	UART2 Transmit Buffer Register	U2TB
0273h	SI/O3 Bit Rate Register	S3BRG
0277h	SI/O4 Bit Rate Register	S4BRG
0289h	UART5 Bit Rate Register	U5BRG
028Bh to 028Ah	UART5 Transmit Buffer Register	U5TB
0299h	UART6 Bit Rate Register	U6BRG
029Bh to 029Ah	UART6 Transmit Buffer Register	U6TB
02A9h	UART7 Bit Rate Register	U7BRG
02ABh to 02AAh	UART7 Transmit Buffer Register	U7TB
02B6h	I2C0 Control Register 1	S3D0
02B8h	I2C0 Status Register 0	S10
0303h to 0302h	Timer A1-1 Register	TA11
0305h to 0304h	Timer A2-1 Register	TA21
0307h to 0306h	Timer A4-1 Register	TA41
030Ah	Three-Phase Output Buffer Register 0	IDB0
030Bh	Three-Phase Output Buffer Register 1	IDB1
030Ch	Dead Time Timer	DTT
030Dh	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2
0327h to 0326h	Timer A0 Register	TA0
0329h to 0328h	Timer A1 Register	TA1
032Bh to 032Ah	Timer A2 Register	TA2
032Dh to 032Ch	Timer A3 Register	TA3
032Fh to 032Eh	Timer A4 Register	TA4
037Dh	Watchdog Timer Refresh Register	WDTR
037Eh	Watchdog Timer Start Register	WDTS

5. Electrical Characteristics

5.1 Electrical Characteristics (Common to 3 V and 5 V)

5.1.1 Absolute Maximum Rating

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter		Condition	Rated Value	Unit
V_{CC1}	Supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to 6.5	V
V_{CC2}	Supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to $V_{CC1} + 0.1$ (1)	V
AV_{CC}	Analog supply voltage		$V_{CC1} = AV_{CC}$	-0.3 to 6.5	V
V_{REF}	Analog reference voltage		$V_{CC1} = AV_{CC}$	-0.3 to $V_{CC1} + 0.1$ (1)	V
V_I	Input voltage	RESET, CNVSS, BYTE, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XIN		-0.3 to $V_{CC1} + 0.3$ (1)	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		-0.3 to $V_{CC2} + 0.3$ (1)	V
		P7_0, P7_1, P8_5		-0.3 to 6.5	V
V_O	Output voltage	P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XOUT		-0.3 to $V_{CC1} + 0.3$ (1)	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7		-0.3 to $V_{CC2} + 0.3$ (1)	V
		P7_0, P7_1, P8_5		-0.3 to 6.5	V
P_d	Power consumption		$-40^{\circ}\text{C} < T_{opr} \leq 85^{\circ}\text{C}$	300	mW
T_{opr}	Operating temperature	When the MCU is operating		-20 to 85/-40 to 85	$^{\circ}\text{C}$
		Flash program erase	Program area Data area	0 to 60 -20 to 85/-40 to 85	
T_{stg}	Storage temperature			-65 to 150	$^{\circ}\text{C}$

Note:

1. Maximum value is 6.5 V.

5.1.2 Recommended Operating Conditions

Table 5.2 Recommended Operating Conditions (1/3)

$V_{CC1} = V_{CC2} = 2.7$ to 5.5 V at $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C unless otherwise specified.

Symbol	Parameter	Standard			Unit	
		Min.	Typ.	Max.		
V_{CC1} , V_{CC2}	Supply voltage ($V_{CC1} \geq V_{CC2}$)	CEC function is not used	2.7	5.0	5.5	V
		CEC function is used	2.7		3.63	V
AV_{CC}	Analog supply voltage		V_{CC1}		V	
V_{SS}	Supply voltage		0		V	
AV_{SS}	Analog supply voltage		0		V	
V_{IH}	High input voltage	P3_1 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	0.8 V_{CC2}		V_{CC2}	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (in single-chip mode)	0.8 V_{CC2}		V_{CC2}	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (data input in memory expansion and microprocessor modes)	0.5 V_{CC2}		V_{CC2}	V
		P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XIN, RESET, CNVSS, BYTE	0.8 V_{CC1}		V_{CC1}	V
		P7_0, P7_1, P8_5	0.8 V_{CC1}		6.5	V
		CEC	0.7 V_{CC1}			V
V_{IL}	Low input voltage	P3_1 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	0		0.2 V_{CC2}	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (in single-chip mode)	0		0.2 V_{CC2}	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (data input in memory expansion and microprocessor mode)	0		0.16 V_{CC2}	V
		P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1 XIN, RESET, CNVSS, BYTE	0		0.2 V_{CC1}	V
		CEC			0.26 V_{CC1}	V
$I_{OH(\text{sum})}$	High peak output current	Sum of $I_{OH(\text{peak})}$ at P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7			-40.0	mA
		Sum of $I_{OH(\text{peak})}$ at P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, and P13_0 to P13_7			-40.0	mA
		Sum of $I_{OH(\text{peak})}$ at P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4			-40.0	mA
		Sum of $I_{OH(\text{peak})}$ at P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0 to P14_1			-40.0	mA
$I_{OH(\text{peak})}$	High peak output current	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			-10.0	mA
$I_{OH(\text{avg})}$	High average output current ⁽¹⁾	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			-5.0	mA

Note:

- The average output current is the mean value within 100 ms.

5.1.6 Voltage Detector and Power Supply Circuit Electrical Characteristics

Table 5.11 Voltage Detector 0 Electrical Characteristics

The measurement condition is $V_{CC1} = 2.7$ to 5.5 V, $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C, unless otherwise specified.

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{det0}	Voltage detection level V_{det0_0} (1)	When V_{CC1} is falling.	1.60	1.90	2.20	V
	Voltage detection level V_{det0_2} (1)	When V_{CC1} is falling.	2.55	2.85	3.15	V
-	Voltage detector 0 response time (3)	When V_{CC1} falls from 5 V to ($V_{det0_0} - 0.1$) V			200	μs
-	Voltage detector self power consumption	$VC25 = 1$, $V_{CC1} = 5.0$ V		1.8		μA
$t_{d(E-A)}$	Waiting time until voltage detector operation starts (2)				100	μs

Notes:

1. Select the voltage detection level with the VDSEL1 bit in the OFS1 address.
2. Necessary time until the voltage detector operates when setting to 1 again after setting the VC25 bit in the VCR2 register to 0.
3. Time from when passing the V_{det0} until when a voltage monitor 0 reset is generated.

Table 5.12 Voltage Detector 1 Electrical Characteristics

The measurement condition is $V_{CC1} = 2.7$ to 5.5 V, $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C, unless otherwise specified.

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{det1}	Voltage detection level V_{det1_6} (1)	When V_{CC1} is falling.	2.79	3.09	3.39	V
	Voltage detection level V_{det1_B} (1)	When V_{CC1} is falling.	3.54	3.84	4.14	V
	Voltage detection level V_{det1_F} (1)	When V_{CC1} is falling.	3.94	4.44	4.94	V
-	Hysteresis width when V_{CC1} of voltage detector 1 is rising			0.15		V
-	Voltage detector 1 response time (3)	When V_{CC1} falls from 5 V to ($V_{det1_0} - 0.1$) V			200	μs
-	Voltage detector self power consumption	$VC26 = 1$, $V_{CC1} = 5.0$ V		1.8		μA
$t_{d(E-A)}$	Waiting time until voltage detector operation starts (2)				100	μs

Notes:

1. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
2. Necessary time until the voltage detector operates when setting to 1 again after setting the VC26 bit in the VCR2 register to 0.
3. Time from when passing the V_{det1} until when a voltage monitor 1 reset is generated.

$$V_{CC1} = V_{CC2} = 5 \text{ V}$$

5.2.2 Timing Requirements (Peripheral Functions and Others)

($V_{CC1} = V_{CC2} = 5 \text{ V}$, $V_{SS} = 0 \text{ V}$, at $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C unless otherwise specified)

5.2.2.1 Reset Input ($\overline{\text{RESET}}$ Input)

Table 5.24 Reset Input ($\overline{\text{RESET}}$ Input)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_w(\text{RTSL})$	RESET input low pulse width	10		μs

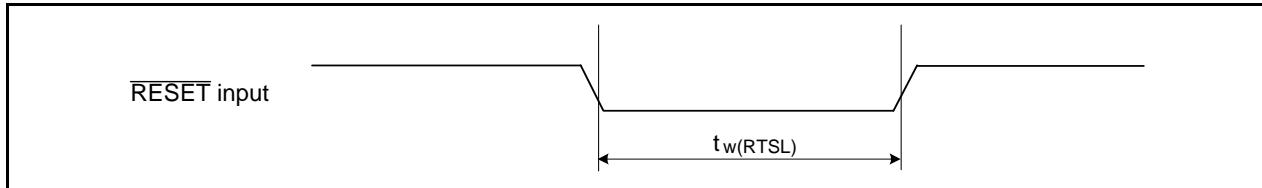


Figure 5.5 Reset Input ($\overline{\text{RESET}}$ Input)

5.2.2.2 External Clock Input

Table 5.25 External Clock Input (XIN Input) (1)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t_c	External clock input cycle time	50		ns
$t_w(H)$	External clock input high pulse width	20		ns
$t_w(L)$	External clock input low pulse width	20		ns
t_r	External clock rise time		9	ns
t_f	External clock fall time		9	ns

Note:

1. The condition is $V_{CC1} = V_{CC2} = 3.0$ to 5.0 V.

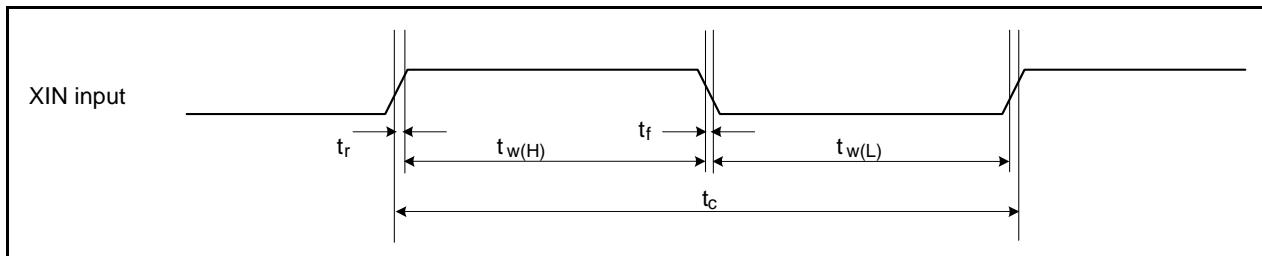
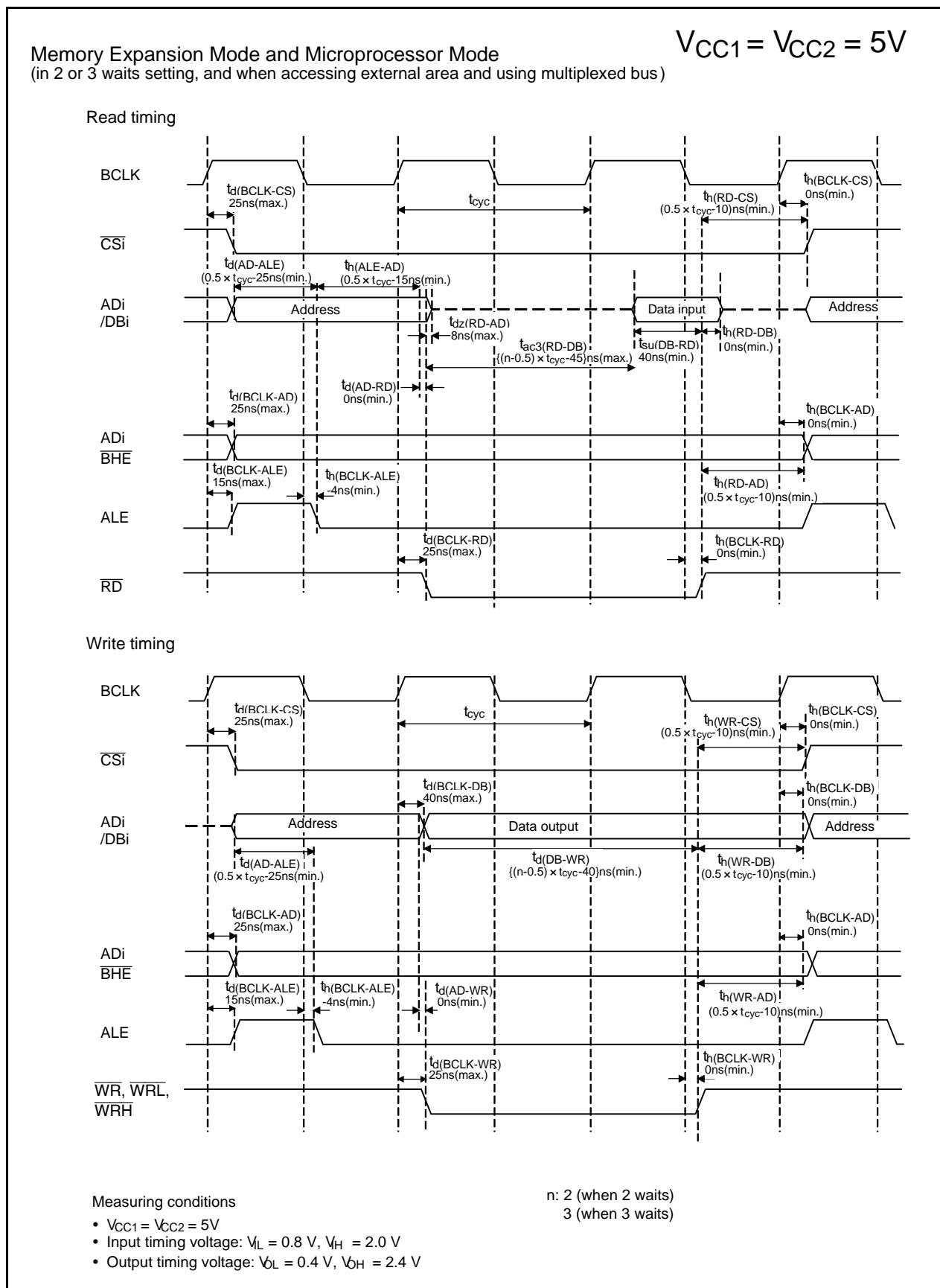
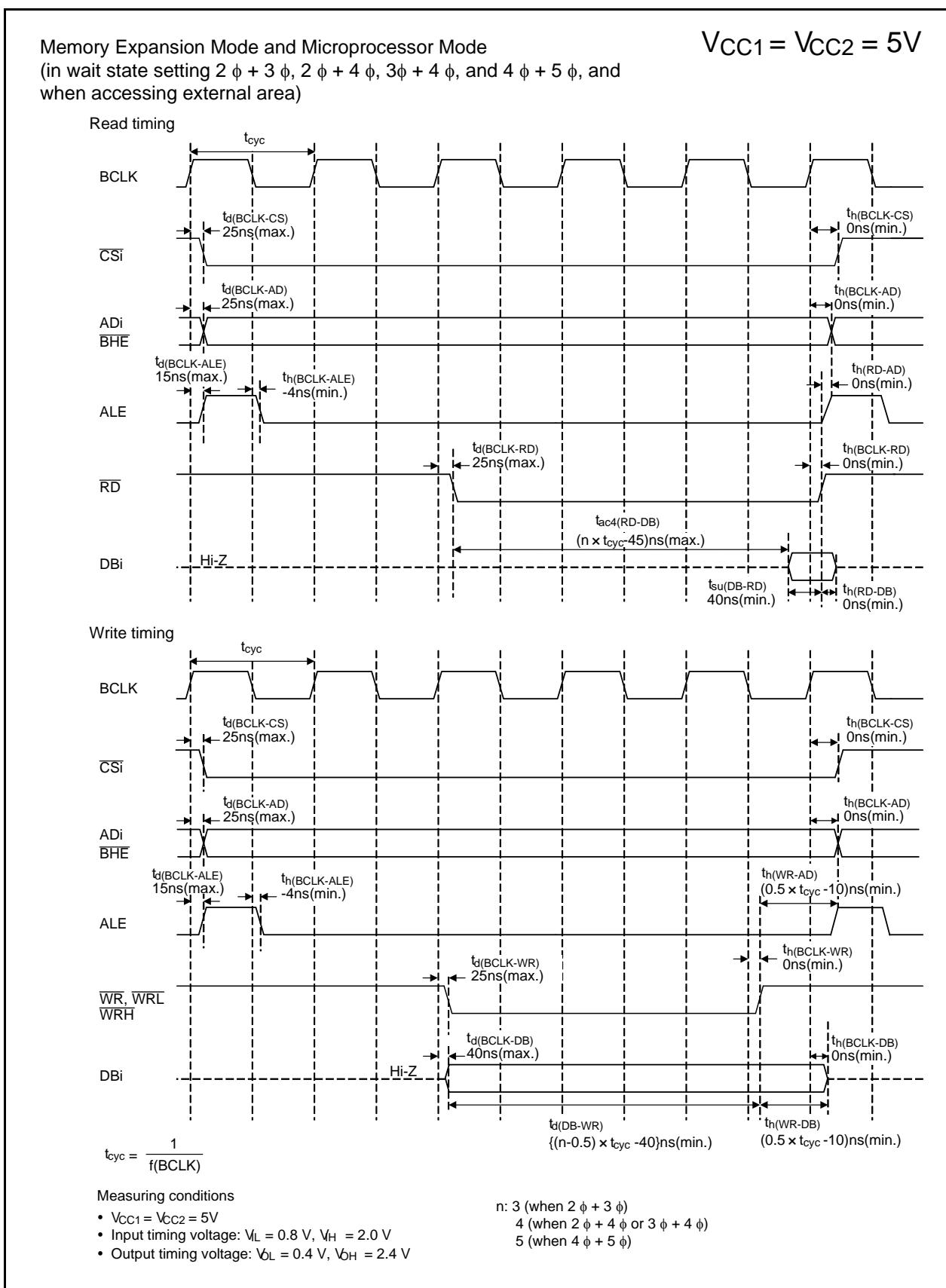


Figure 5.6 External Clock Input (XIN Input)

**Figure 5.17 Timing Diagram**

**Figure 5.18 Timing Diagram**

$$V_{CC1} = V_{CC2} = 3 \text{ V}$$

Timing Requirements

($V_{CC1} = V_{CC2} = 3 \text{ V}$, $V_{SS} = 0 \text{ V}$, at $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C unless otherwise specified)

5.3.3 Timing Requirements (Memory Expansion Mode and Microprocessor Mode)

Table 5.60 Memory Expansion Mode and Microprocessor Mode

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{ac1(RD-DB)}$	Data input access time (for setting with no wait)		(Note 1)	ns
$t_{ac2(RD-DB)}$	Data input access time (for setting with wait)		(Note 2)	ns
$t_{ac3(RD-DB)}$	Data input access time (when accessing multiplex bus area)		(Note 3)	ns
$t_{ac4(RD-DB)}$	Data input access time (for setting with 2 ϕ + 3 ϕ or more)		(Note 4)	ns
$t_{su(DB-RD)}$	Data input setup time	50		ns
$t_{su(RDY-BCLK)}$	RDY input setup time	85		ns
$t_h(RD-DB)$	Data input hold time	0		ns
$t_h(BCLK-RDY)$	RDY input hold time	0		ns

Notes:

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 60[\text{ns}]$$

- Calculated according to the BCLK frequency as follows:

$$\frac{(n + 0.5) \times 10^9}{f_{(BCLK)}} - 60[\text{ns}] \quad n \text{ is 1 for 1 wait setting, 2 for 2 waits setting and 3 for 3 waits setting.}$$

- Calculated according to the BCLK frequency as follows:

$$\frac{(n - 0.5) \times 10^9}{f_{(BCLK)}} - 60[\text{ns}] \quad n \text{ is 2 for 2 waits setting, 3 for 3 waits setting.}$$

- Calculated according to the BCLK frequency as follows:

$$\frac{n \times 10^9}{f_{(BCLK)}} - 60[\text{ns}] \quad n \text{ is 3 for } 2\phi + 3\phi, 4 \text{ for } 2\phi + 4\phi, 4 \text{ for } 3\phi + 4\phi, 5 \text{ for } 4\phi + 5\phi, \dots$$

$$V_{CC1} = V_{CC2} = 3 \text{ V}$$

Switching Characteristics

($V_{CC1} = V_{CC2} = 3 \text{ V}$, $V_{SS} = 0 \text{ V}$, at $T_{opr} = -20^\circ\text{C}$ to 85°C /-40°C to 85°C unless otherwise specified)

5.3.4.4 In Wait State Setting 2φ + 3φ, 2φ + 4φ, 3φ + 4φ, and 4φ + 5φ, and When Accessing External Area

Table 5.64 Memory Expansion and Microprocessor Modes (in Wait State Setting 2φ + 3φ, 2φ + 4φ, 3φ + 4φ, and 4φ + 5φ, and When Accessing External Area)

Symbol	Parameter	Measuring Condition	Standard		Unit
			Min.	Max.	
$t_d(BCLK-AD)$	Address output delay time	See Figure 5.29		30	ns
$t_h(BCLK-AD)$	Address output hold time (in relation to BCLK)		0		ns
$t_h(RD-AD)$	Address output hold time (in relation to RD)		0		ns
$t_h(WR-AD)$	Address output hold time (in relation to WR)		(Note 2)		ns
$t_d(BCLK-CS)$	Chip select output delay time			30	ns
$t_h(BCLK-CS)$	Chip select output hold time (in relation to BCLK)		0		ns
$t_d(BCLK-ALE)$	ALE signal output delay time			25	ns
$t_h(BCLK-ALE)$	ALE signal output hold time		-4		ns
$t_d(BCLK-RD)$	RD signal output delay time			30	ns
$t_h(BCLK-RD)$	RD signal output hold time		0		ns
$t_d(BCLK-WR)$	WR signal output delay time			30	ns
$t_h(BCLK-WR)$	WR signal output hold time		0		ns
$t_d(BCLK-DB)$	Data output delay time (in relation to BCLK)			40	ns
$t_h(BCLK-DB)$	Data output hold time (in relation to BCLK) (3)		0		ns
$t_d(DB-WR)$	Data output delay time (in relation to WR)		(Note 1)		ns
$t_h(WR-DB)$	Data output hold time (in relation to WR) (3)		(Note 2)		ns

Notes:

- Calculated according to the BCLK frequency as follows:

$$\frac{(n - 0.5) \times 10^9}{f_{(BCLK)}} - 40[\text{ns}] \quad n \text{ is } 3 \text{ for } 2\phi + 3\phi, 4 \text{ for } 2\phi + 4\phi, 4 \text{ for } 3\phi + 4\phi, \text{ and } 5 \text{ for } 4\phi + 5\phi.$$

- Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f_{(BCLK)}} - 10[\text{ns}]$$

- This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

Hold time of data bus is expressed in

$$t = -CR \times \ln(1 - V_{OL}/V_{CC2})$$

by a circuit of the right figure.

For example, when $V_{OL} = 0.2V_{CC2}$, $C = 30 \text{ pF}$, $R = 1 \text{ k}\Omega$, hold time of output low level is

$$t = -30 \text{ pF} \times 1 \text{ k}\Omega \times \ln(1 - 0.2V_{CC2}/V_{CC2}) \\ = 6.7 \text{ ns.}$$

